Silicon RF Power Semiconductors ELECTROSTATIC SENSITIVE DEVICE

OBSERVE HANDLING PRECAUTIONS

RD15HVF1

RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz520MHz,15W

DESCRIPTION

RD15HVF1 is a MOS FET type transistor specifically designed for VHF/UHF High power amplifiers applica -tions.

FEATURES

High power and High Gain:
Pout>15W, Gp>14dB @Vdd=12.5V,f=175MHz
Pout>15W, Gp>7dB @Vdd=12.5V,f=520MHz
High Efficiency: 60%typ. on VHF Band
High Efficiency: 55%typ. on UHF Band

APPLICATION

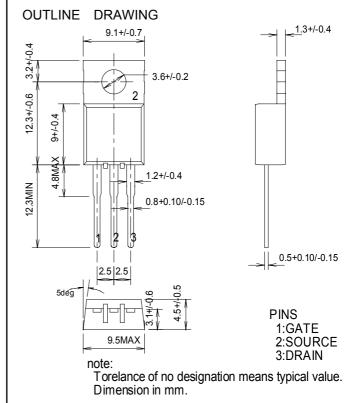
For output stage of high power amplifiers in VHF/UHF Band mobile radio sets.

Rohs Compliant

RD15HVF1-101 is a RoHS compliant products. RoHS compliance is indicate by the letter "G" after the lot marking.

This product include the lead in high melting temperature type solders. How ever,it applicable to the following exceptions of RoHS Directions.

1.Lead in high melting temperature type solders(i.e.tin-lead solder alloys containing more than 85% lead.)



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ABSOLUTE MAXIMUM RATINGS

(Tc=25°C UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
VDSS	Drain to source voltage	Vgs=0V	30	V
Vgss	Gate to source voltage	Vds=0V	+/-20	V
Pch	Channel dissipation	Tc=25°C	48	W
Pin	Input power	Zg=Zl=50Ω	1.5(Note2)	W
ID	Drain current	-	4	Α
Tch	Channel temperature	-	150	°C
Tstg	Storage temperature	-	-40 to +150	°C
Rth j-c	Thermal resistance	junction to case	2.6	°C/W

Note 1: Above parameters are guaranteed independently.

Note 2: Over 300MHz use spec is 6W

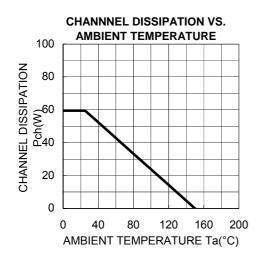
ELECTRICAL CHARACTERISTICS (Tc=25°C, UNLESS OTHERWISE NOTED)

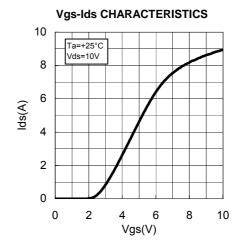
SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
31WBOL TARAWETER		CONDITIONS	MIN	TYP	MAX.	
IDSS	Zero gate voltage drain current	VDS=17V, VGS=0V	-	-	100	uA
IGSS	Gate to source leak current	VGS=10V, VDS=0V	-	-	1	uA
VTH	Gate threshold Voltage	VDS=12V, IDS=1mA	1.5	2.0	2.5	V
Pout1	Output power	VDD=12.5V, Pin=0.6W,	15	18	-	W
ηD1	Drain efficiency	f=175MHz,ldq=0.5A	55	60	-	%
Pout2	Output power	V _{DD} =12.5V, Pin=3W,	15	18	-	W
ηD2	Drain efficiency	f=520MHz,Idq=0.5A	50	55	-	%
	Load VSWR tolerance	V _{DD} =15.2V,Po=15W(PinControl)	No destroy		-	
		f=175MHz,ldq=0.5A,Zg=50 Ω				
		Load VSWR=20:1(All Phase)				
	Load VSWR tolerance	VDD=15.2V,Po=15W(PinControl)	No destroy		-	
	f=520MHz,ldq=0.5A,Zg=50 Ω					
	Load VSWR=20:1(All Phase)					

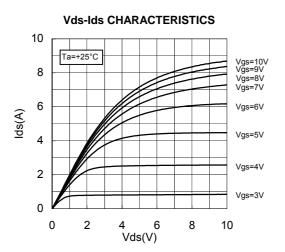
Note: Above parameters, ratings, limits and conditions are subject to change.

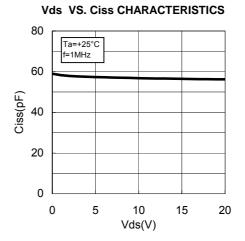
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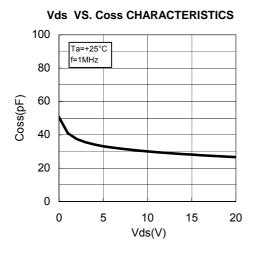
TYPICAL CHARACTERISTICS

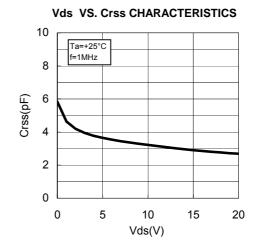






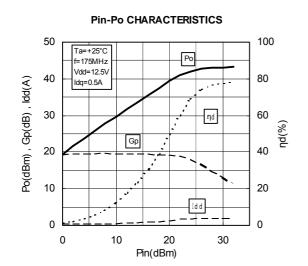


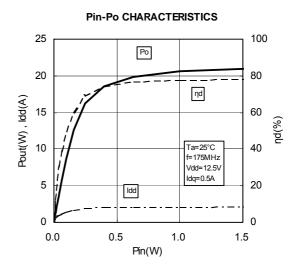


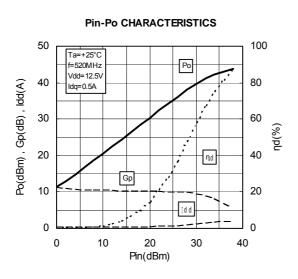


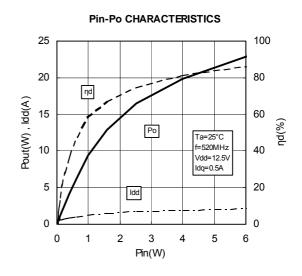
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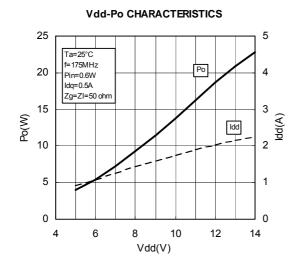
TYPICAL CHARACTERISTICS

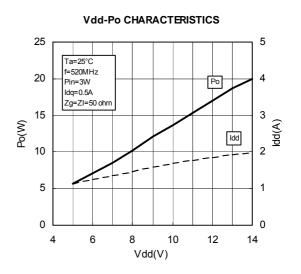






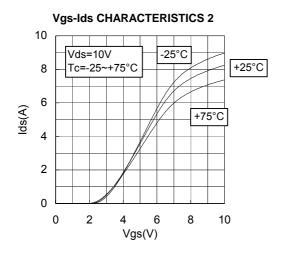




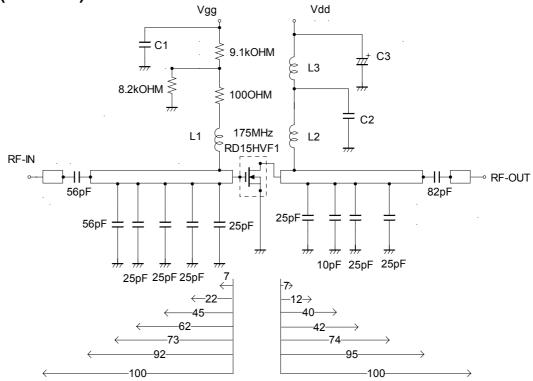


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TYPICAL CHARACTERISTICS



TEST CIRCUIT(f=175MHz)



C1:2200pF 10uF in parallel C2:2200pF*2 in parallel C3:2200pF,330uF in parallel Note:Board material-Teflon substrate micro strip line width=4.2mm/50OHM,er:2.7,t=1.6mm

Dimensions:mm

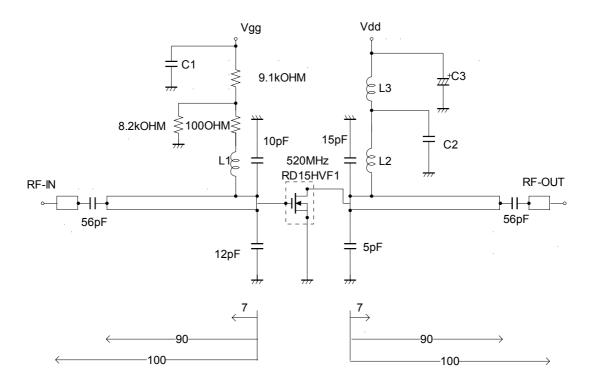
L1:4Turns,I.D6mm,D1.6mm P=1 silver plateted copper wire

L2:5Turns,I.D6mm,D1.6mm P=1 silver plateted copper wire

L3:4Turns,I.D6mm,D1.6mm P=1 silver plateted copper wire

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TEST CIRCUIT(f=520MHz)



C1:2200pF 10uF in parallel C2:2200pF*2 in parallel C3:2200pF,330uF in parallel Note:Board material-Teflon substrate micro strip line width=4.2mm/50OHM,er:2.7,t=1.6mm

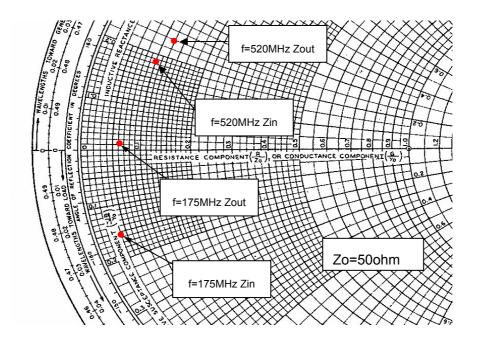
Dimensions:mm

L1:4Turns,I.D6mm,D1.6mm P=1 silver plateted copper wire L2:2Turns,I.D6mm,D1.6mm P=1 silver plateted copper wire L3:4Turns,I.D6mm,D1.6mm P=1 silver plateted copper wire

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INPUT/OUTPUT IMPEDANCE VS.FREQUENCY CHARACTERISTICS

OBSERVE HANDLING PRECAUTIONS



Zin, Zout

f	Zin	Zout	
(MHz)	(ohm)	(ohm)	Conditions
175	2.34-j8.01	3.06+j0.74	Po=15W, Vdd=12.5V,Pin=0.6W
520	5.42+j9.22	6.02+j12.34	Po=15W, Vdd=12.5V,Pin=3.0W

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RD15HVF1 S-PARAMETER DATA (@Vdd=12.5V, Id=500mA)

Freq.	S11		S21		S12		S22	
[MHz]	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
50	0.717	-145.9	23.274	101.8	0.023	26.0	0.556	-130.2
100	0.726	-163.9	12.054	85.7	0.024	27.7	0.547	-150.4
150	0.744	-171.1	8.049	74.7	0.025	36.1	0.560	-157.8
175	0.748	-173.6	6.804	70.2	0.025	41.8	0.571	-160.1
200	0.755	-175.9	5.886	66.3	0.026	48.1	0.588	-161.8
250	0.770	-179.0	4.622	58.6	0.030	57.7	0.625	-164.3
300	0.787	177.6	3.731	51.5	0.036	65.3	0.647	-167.5
350	0.804	174.6	3.092	45.3	0.044	70.3	0.683	-170.9
400	0.821	171.2	2.623	39.1	0.053	73.5	0.716	-173.7
450	0.838	168.2	2.229	33.2	0.062	74.6	0.734	-176.8
500	0.849	165.1	1.938	28.3	0.072	73.9	0.765	179.4
520	0.854	163.7	1.845	26.1	0.076	73.9	0.777	178.0
550	0.862	161.7	1.695	22.9	0.082	72.6	0.788	176.3
800	0.900	145.0	0.971	4.2	0.135	62.8	0.859	159.0
850	0.904	141.3	0.864	0.0	0.143	59.6	0.870	155.7
900	0.909	137.9	0.790	-1.4	0.153	57.8	0.877	152.4
950	0.910	134.6	0.738	-4.4	0.163	54.8	0.880	149.0
1000	0.910	131.2	0.662	-6.8	0.170	51.4	0.886	145.7
1050	0.911	127.5	0.612	-8.4	0.178	49.4	0.892	142.1

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ATTENTION:

- 1.High Temperature; This product might have a heat generation while operation, Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product, do not place the combustible material that have possibilities to arise the fire.
- 2.Generation of High Frequency Power; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
- 3.Before use; Before use the product, Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

- 1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
- 2. RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements. Examples of critical communications elements would include transmitters for base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, especially for systems that may have a high impact to society.
- 3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
- 4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
- 5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of Tchmax=150deg/C),140deg/C(in case of Tchmax=175deg/C) under standard conditions.
- 6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
- 7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
- 8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
- 9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.
- 10. Please refer to the additional precautions in the formal specification sheet.

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Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

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